

Filename: PMP2942_REV_B_bom.xls

Date: 10/03/2007

PMP2942_REV_B BOM

COUNT	RefDes	Value	Description	SIZE	Part Number	MFR	AREA
1	C1	270p	Capacitor, Ceramic, 50V, NPO, [tol]	0603	std	std	5650
1	C10	10uF	Capacitor, Ceramic, 25V, [temp], [tol]	1210	Std	std	83,600
2	C11, C12	3.3uF	Capacitor, Ceramic, 50V, X7R, 20%	1210	Std	std	83,600
1	C2	0.22u	Capacitor, Ceramic, 16V, [temp], [tol]	0603	std	std	5650
1	C3	100p	Capacitor, Ceramic, 50V, X7R, [tol]	0603	std	std	5650
1	C4	3300p	Capacitor, Ceramic, 50V, [temp], [tol]	0603	std	std	5650
1	C5	0.1u	Capacitor, Ceramic, 25V, [temp], [tol]	0603	std	std	5650
1	C7	1u	Capacitor, Ceramic, 16V, X7R, 20%	0603	std	std	5650
1	C9	22p	Capacitor, Ceramic, vvV, [temp], [tol]	0603	std	std	5650
1	D1	MBRS460	Diode, 4A, 60V	SMC	MBRS460	Onsemi	95000
2	J1, J2	D120/2DS	Terminal Block, 2-pin, 15-A, 5.1mm	0.40 x 0.35 inch	D120/2DS	OST	141600
1	L1	12u	Inductor, SMT, 4.9A, 24-milliohm	0.485 sq inch	CDRH127-120	Sumida	95275
1	L4	2.2 uH	Inductor, SMT, 2A, 23milliohm	0.200 x 0.200 in	MSS5131-222MX_	Coilcraft	65
1	Q1	Si7308DN	MOSFET, Fast Switching, NChan, 60V, 6A, 59milliohm	PWRPAK 1212	Si7110DN	Vishay	27200
1	R1	249k	Resistor, Chip, 1/16W, 1%	0603	std	std	9100
1	R10	1k	Resistor, Chip, 1/16W, 1%	0603	std	std	9100
1	R100	1	Resistor, Chip, 1W, 1%	2512	WSL-2512-xx 1% F	STD	35100
1	R11	0.02	Resistor, Chip, 1W, 1%	2512	WSL-2512-xx 1% F	STD	35100
1	R2	7.5k	Resistor, Chip, 1/16W, 1%	0603	std	std	9100
1	R3	1.62k	Resistor, Chip, 1/16W, 1%	0603	std	std	9100
1	R5	49.9k	Resistor, Chip, 1/16W, 1%	0603	std	std	9100
1	R7	10	Resistor, Chip, 1/16W, 1%	0603	std	std	9100
1	U1	TPS40210DGS	IC, Low Cost Non-Synchronous Boost Controller	DGS10	TPS40210DGS	TI	26780

- Notes:
1. These assemblies are ESD sensitive, ESD precautions shall be observed.
 2. These assemblies must be clean and free from flux and all contaminants.
Use of no clean flux is not acceptable.
 3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.
 4. Ref designators marked with an asterisk (***) cannot be substituted.
All other components can be substituted with equivalent MFG's components.

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